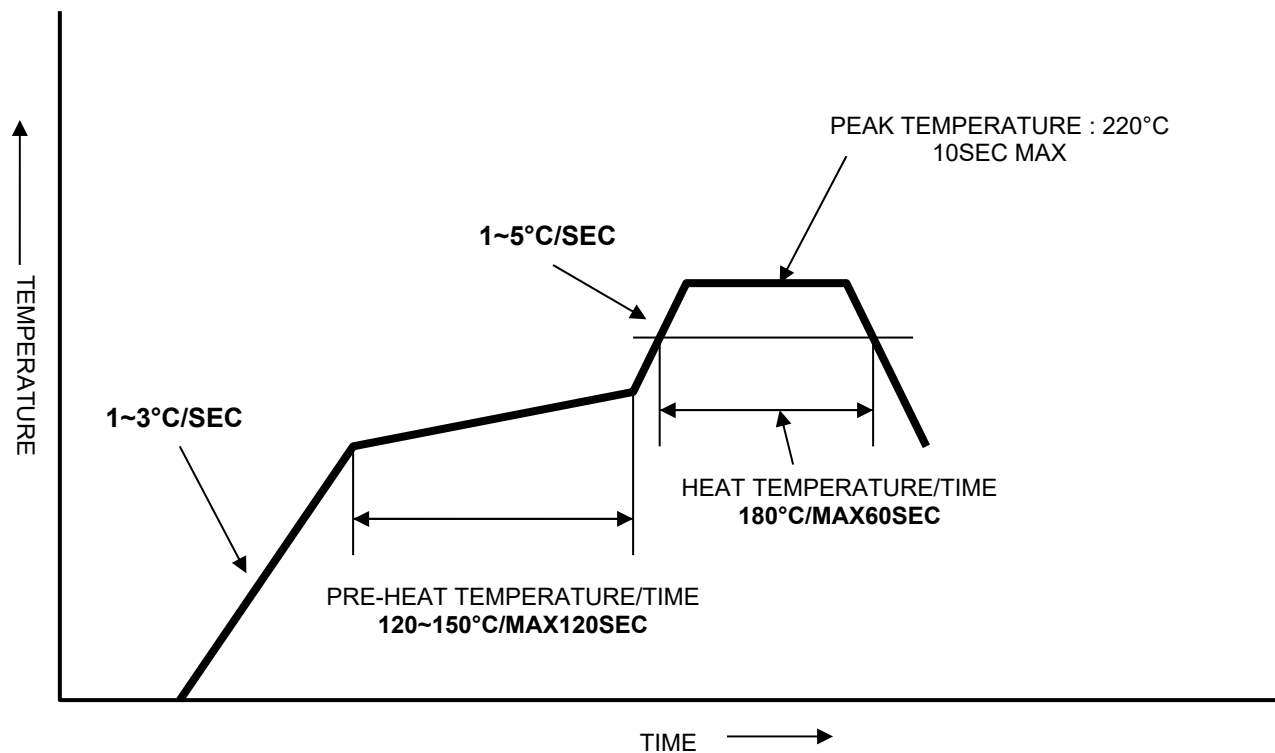


Application Note: AN0025

Recommended Solder Reflow Temperature Profile for Leaded Parts



For detailed mounting instruction, please refer to the following application notes:

- AN0006 – Wrapped Chip Device Mounting Instructions
- AN0007 – High-Power Load, Resistor, and Attenuator Mounting Instructions
- AN0030 – General Hybrid and Directional Coupler Application Note